

Electronic Acknowledgement Receipt

EFS ID:	1169822
Application Number:	10566949
Confirmation Number:	3062
Title of Invention:	Plating solution, process for producing a structure with the plating solution, and apparatus employing the plating solution
First Named Inventor:	Shigeru Ichihara
Customer Number:	5514
Filer:	Jason M. Okun/DAVID NGUY
Filer Authorized By:	Jason M. Okun
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File Listing:

Document Number	Document Description	File Name	File Size(Bytes)	Multi Part	Pages
1	Request for Corrected Filing Receipt	ReqCorrOFR03500103072U SB100.pdf	5356	no	2

Warnings:	
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<p>National Stage of an International Application under 35 U.S.C. 371 If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.</p>	